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112

DIM

DIM "A"

DIM "B"

DIM "C"

DIM "D"

3 |

.250 [6.35] x DD + .100 [2.54] x (CCC/4) + .250 [6.35] x BB + .650 [16.51] (NOTE 10)

.250 [6.35] x DD + .100 [2.54] x (CCC/4) + .250 [6.35] x BB + .350 [8.89]

.250 [6.35] x DD + .100 [2.54] x (CCC/4) + .250 [6.35] x BB + .300 [7.62]

.250 [6.35] x DD + .375 [9.53]

DIM "E" .250 [6.35] x DD + .100 [2.54] x (CCC/4) + .450 [11.43]

DIM "F" .250 [6.35] x DD + .100 [2.54] x (CCC/4) + .250 [6.35] x BB + .680 [17.27]

DIM "G" .250 [6.35] x DD + .225 [5.72]

DIM "H" .250 [6.35] x DD + .100 [2.54] x (CCC/4) + .250 [6.35]

LENGTH FORMULAS (SEE NOTE 10)

CONNECTOR NOTES

PRODUCT NUMBER

51740-ABBCCCDDEF__ Note: (+)

SEE NOTE

PRODUCT NUMBER CODE: 51740 - A BB CCC DD E F LF NO THIS SUFFIX: 100u"/2.54um SnPb ON PCB INTERFACE
ADD THIS SUFFIX: 78u"/2.00um Sn OR 5u" Au ON PCB INTERFACE RETENTION TO PCB (NOTE 8) TAIL OPTIONS (NOTE 7) - NUMBER OF LEFT END POWER CONTACTS (NOTE 6)
- NUMBER OF SIGNAL CONTACTS (NOTE 5)
- NUMBER OF RIGHT POWER CONTACTS (NOTE 4) -PLATING (NOTE 3) -BASE NUMBER

HOUSING MATERIAL: GLASS FILLED V-O HIGH TEMP THERMO PLASTIC. SIGNAL CONTACT MATERIAL: COPPER ALLOY

POWER CONTACT MATERIAL: COPPER ALLOY

PLATING OPTION: I = SIGNAL CONTACTS: 50u" / 1.27um Ni UNDER ALL;30u" / 0.76um Au ON THE CONTACT AREA AND
WITH 100u"/2.54um SnPb OR 78u"/2.00um Sn ON PCB INTERFACE
POWER CONTACTS: 50u" / 1.27um Ni UNDER ALL; WITH 30u" / 76um Au ON CONTACT AREA
WITH 100u"/2.54um SnPb OR 78u"/2.00um Sn ON PCB INTERFACE

3 = SIGNAL CONTACTS: 50u" / 1.27um Ni UNDER ALL:30u" / 0.76um Au ON THE CONTACT AREA AND WITH 5u"/0.13um Au ONPCB INTERFACE)

POWER CONTACTS: 50u" / I.27um Ni UNDER ALL; WITH 30u" / 76um Au ON CONTACT AREA

WITH 5u"/0.13um Au ON PCB INTERFACE

RIGHT END POWER CONTACT, 01 TO 20 AVAILABLE.
MAXIMUM OF 20 POWER CONTACTS PER CONNECTOR.

SIGNAL CONTACTS, 004 TO 148 AVAILABLE

LEFT END POWER CONTACTS, 01 TO 20 AVAILABLE. MAXIMUM OF 20 POWER CONTACTS PER CONNECTOR.

A = .135 \pm 0.010 [3.43 \pm 0.25] SOLDER TO BOARD $C = .135 \pm 0.010 [3.43 \pm 0.25]$ PRESS FIT

RETENTION TO PCB OPTIONS: A = BOARD LOCK (REQUIRES .098 + .002, -.001 [2.49 +0.05, -0.03] THRU HOLE IN PCB) RECOMMENDED ON SYMMETRIC CONNECTORS. BOARD LOCK TO BE USED IN CONJUNCTION WITH AN .092 PCB OR THICKER. C = NO RETENTION FEATURE.

MANUFACTURE'S NAME, P/N, AND DATE CODE TO APPEAR ON THIS SURFACE.

THE MAXIMUM OVERALL LENGTH (DIM A) OF A PART IS 8.00 [203.21.

II. PRODUCT SPECIFICATION GS-12-149.

12. REFERENCE 51698 FOR SPECIALS WORKSHEET.

PCB_NOTES:

13. ALL DIMENSIONS ARE BASIC UNLESS OTHERWISE SPECIFIED

14. ALL THROUGH HOLES ARE LOCATED WITH A TRUE POSITION OF .004 [0.01]

15. ALL HOLE DIAMETERS ARE FINISHED HOLE SIZE.

16. 0.0453±.001 [1.151±.02] DRILLED HOLES PLATED WITH 0.0003 [0.007] MIN SnPb OVER 0.001 [1.03] TO .003 [0.08] PLATING TO ACHIEVE A .040 \pm .003 [1.02 \pm .08] HOLE.

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PDM: Rev:M

STATUS: Released

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Pro/E

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